PCN Number:	20180713000	PCN Date:	Aug. 20, 2018	
Title: Datasheet for	or TPS7A52-Q1			
Customer Contact:	PCN Manager		Dept: Quality Services	
Change Type:				
Assembly Site	Desig		Wafer Bump Site	
Assembly Process		Sheet	Wafer Bump Material	
		number change	Wafer Bump Process	
		Site Process	Wafer Fab Site	
		FIDCESS	Wafer Fab Process	
Notification Details				
Description of Change:				
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.				
Changes from Povision A	(Eebruary 2019) to Pevicia	n P	SBVS296B - SEPTEMBER 2017 - REVISED JUNE 2018	
Changes from Revision A (February 2018) to Revision B Page				
 Added new RTK (VQFNP) package and associated content				
Changed Figure 48 to load transient plot				
The datasheet number Device Family	will be changing.	Change From:	Change To:	
Device Family		-		
TPS7A52-Q1		SBVS296A	SBVS296B	
These changes may be reviewed at the datasheet links provided.				
http://www.ti.com/product/TPS7A52-Q1				
Reason for Change:				
To accurately reflect device characteristics.				
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):				
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.				
Changes to product identification resulting from this PCN:				
None.				
Product Affected:				
TPS7A5201QRGRRQ1	TPS7A5201WQRTK	RQ1		
For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.				

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com